

DC- 40 GHz Flip Chip Resistive Divider



www.knowlescapacitors.com

PDR06380

DESCRIPTION

A flip chip resistive divider ideal for applications where small size and broad band performance are critical for success. This component is ideal for test and measurement and optical applications. The divider is provided with all pads ENIG plated for solder surface mount integration.

Packaging and Ordering Information: To request Tape and Reel packaging, please order part number PDR06380T, see additional data on page 6.

FEATURES

- Small Size
- Frequency Stable over Temperature
- Flip Chip Solder Surface Mountable
- Moisture Sensitivity Level: MSL1
- Operating & Storage Temp: -55°C to +125°C
- Characteristic Impedance: 50Ω

SPECIFICATIONS*

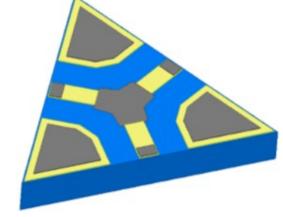
| Parameter | Frequency | Min | Тур | Max | | |
|----------------------------|------------|--------------------------|-------|-----|--|--|
| Excess Insertion Loss (dB) | DC - 40GHz | | 0.5dB | 1dB | | |
| Return Loss (dB) | DC - 30GHz | 20dB | 25dB | | | |
| Neturi Loss (ub) | 30-40GHz | 10dB | 15dB | | | |
| Sizo /Ly/MyU\ | | 0.075 x 0.065 x 0.010 in | | | | |
| Size (LxWxH) | | 1.905 x 1.651 x 0.254 mm | | | | |

*Electrical specifications based on typical probed performance at room temperature. Insertion loss shall vary ±0.5dB over temperature.









2777 Route 20 East, Cazenovia, NY 13035| Ph.: (315)655-8710



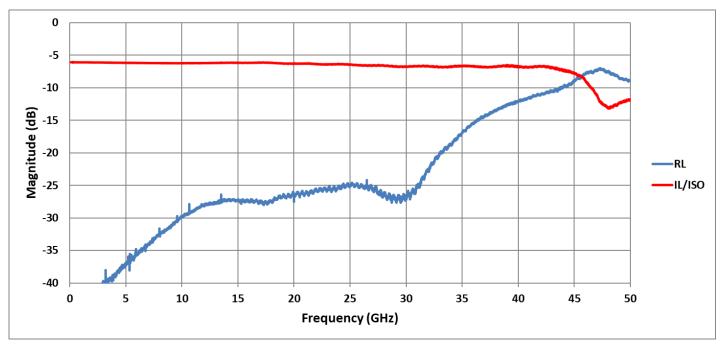


DC-40 GHz Flip Chip Resistive Divider

PDR06380

www.knowlescapacitors.com

Typical Measured Performance



^{*}Typical de-embedded measured performance mounted on a connectorized test fixture. DEB is 0.010in RO4350B with 50.00hm CPW ground traces going into the ports at room temperature.



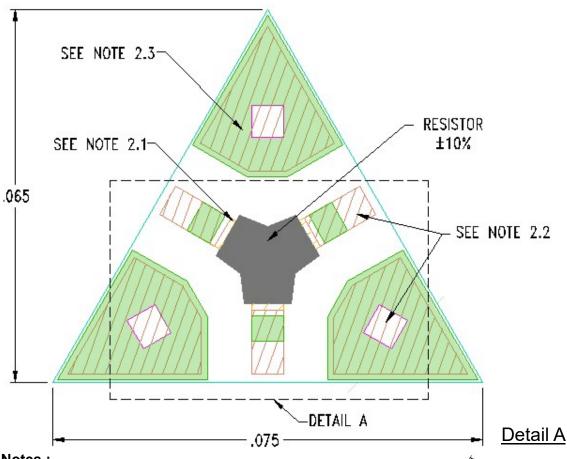




PDR06380

www.knowlescapacitors.com

Detailed Physical Dimensions



Notes:

1. Maximum Assembly Process Temperature: 250°C

2.1 and 2.2 Mounting Surface Metallization:

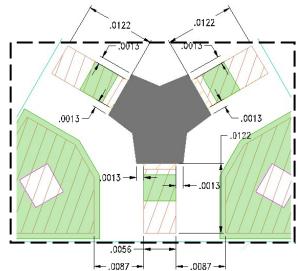
ENIG: 3 - 6 µinch Au over 50 µinch Ni

2.3 Solder Resistant NiOx areas (green)

Tolerances:

For values with 3 decimal places ±0.001

For values with 4 decimal places ±0.0005



2777 Route 20 East, Cazenovia, NY 13035| Ph.: (315)655-8710

To Order Contact KCCSales@knowles.com | For Technical Inquiries Contact DLlengineering@knowles.com





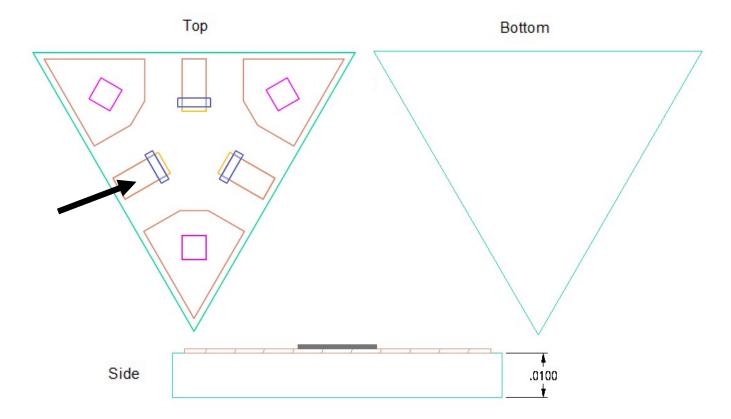
DC- 40 GHz Flip Chip Resistive Divider

PDR06380

www.knowlescapacitors.com

Notes on Part Configuration - Considerations for Stencil Design

Units = inches



This part is mounted with the **Top** side attached to PCB.

Critical areas to solder are as follows:

IOs: Areas in the middle of each side - Indicated with an arrow

Grounding Pads: Squares in corners (in magenta)

Solder stencil apertures should align with all 6 areas and may need dimensions larger than the pads to facilitate consistent solder deposition, depending on chosen stencil thickness. Since the surrounding areas are resistant to solder, the connection will be constrained to the pad. Excess solder is a concern, so best practice is to choose the smallest aperture size with good release in the assembly process.

2777 Route 20 East, Cazenovia, NY 13035| Ph.: (315)655-8710

To Order Contact KCCSales@knowles.com | For Technical Inquiries Contact DLlengineering@knowles.com



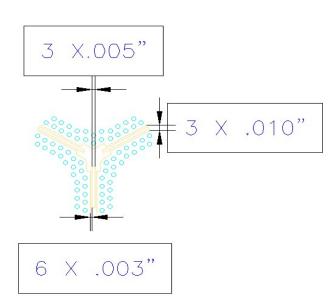
DC-40 GHz Flip Chip Resistive Divider



www.knowlescapacitors.com

PDR06380

Recommended PCB Layout (Unit = inches)



Recommend PCB board:

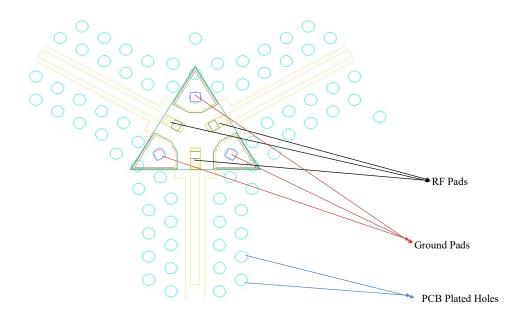
RF signal is carried on 50.0Ω GCPW trace with the following critical dimensions :

10.0 mil thick Alumina (AL) board

5.0 mil width RF trace (copper)

3.0 mil gap between the RF trace and PCB ground.

Detail: PDR06380 Mounted on Recommend PCB



2777 Route 20 East, Cazenovia, NY 13035| Ph.: (315)655-8710

To Order Contact KCCSales@knowles.com | For Technical Inquiries Contact DLlengineering@knowles.com



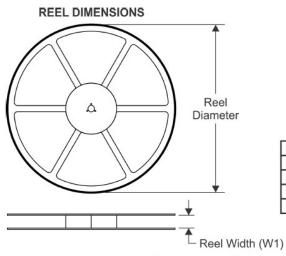


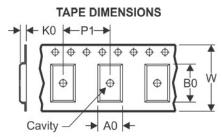
DC- 40 GHz Flip Chip Resistive Divider

PDR06380

www.knowlescapacitors.com

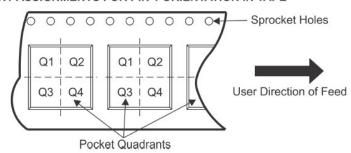
TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| | Dimension designed to accommodate the component thickness |
| | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | , | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|-----------------|--------------------|---|-----|--------------------------|--------------------------|------|------------|------------|------------|-----------|------------------|
| PDR06380-T | SMD | | 3 | TBD | 180.0 | 8.5 | 2.25 | 1.95 | 0.047 | 4.0 | 8.0 | Q1/2 |

2777 Route 20 East, Cazenovia, NY 13035| Ph.: (315)655-8710